5-Bit Magnitude Comparator

Description

The MC10H166 is a 5–Bit Magnitude Comparator and is a functional/pinout duplication of the standard MECL $10K^{\text{TM}}$ part with 100% improvement in propagation delay and no increase in power–supply current.

The MC10H166 is a high–speed expandable 5-bit comparator for comparing the magnitude of two binary words. Two outputs are provided: A < B and A > B. The A = B function can be obtained by wire–ORing these outputs (a low level indicates A = B) or by wire–NORing the outputs (a high level indicates A = B). A high level on the enable function forces both outputs low.

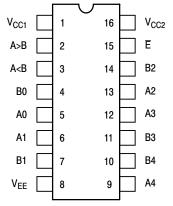
Features

- Propagation Delay, Data-to-Output, 2.0 ns Typical
- Power Dissipation 440 mW Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K Compatible
- Pb-Free Packages are Available*

TRUTH TABLE

| | Inputs | Outputs | | |
|---|--------|----------|-------|-------|
| Ē | Α | В | A < B | A > B |
| Н | х х | | L | L |
| L | WORD A | = WORD B | L | L |
| L | WORD A | > WORD B | L | Н |
| L | WORD A | < WORD B | H | L |

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 18 of the ON Semiconductor MECL Data Book (DL122/D).

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



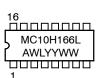
ON Semiconductor®

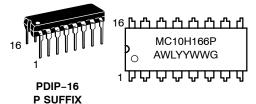
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MARKING DIAGRAMS*





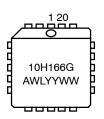






CASE 648

PLLC-20 FN SUFFIX CASE 775



A = Assembly Location
WL, L = Wafer Lot
YY, Y = Year
WW, W = Work Week
G = Pb-Free Package

*For additional marking information, refer to Application Note AND8002/D.

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

Table 1. MAXIMUM RATINGS

| Symbol | Characteristic | Rating | Unit |
|------------------|---|----------------------------|------|
| V _{EE} | Power Supply (V _{CC} = 0) | -8.0 to 0 | Vdc |
| VI | Input Voltage (V _{CC} = 0) | 0 to V _{EE} | Vdc |
| l _{out} | Output Current – Continuous – Surge | 50 100 | mA |
| T _A | Operating Temperature Range | 0 to +75 | °C |
| T _{stg} | Storage Temperature Range - Plastic - Ceramic | -55 to +150 -55 to +165 | °C |

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

Table 2. ELECTRICAL CHARACTERISTICS (V_{EE} = -5.2 V $\pm 5\%$) (Note 1)

| | | 0 ° | | 25 ° | | 75 ° | | |
|------------------|----------------------|------------|-------|-------------|-------|-------------|--------|------|
| Symbol | Characteristic | Min | Max | Min | Max | Min | Max | Unit |
| ΙE | Power Supply Current | - | 117 | - | 106 | - | 117 | mA |
| I _{inH} | Input Current High | - | 350 | - | 220 | - | 220 | μА |
| I _{inL} | Input Current Low | 0.5 | - | 0.5 | - | 0.3 | - | μА |
| V _{OH} | High Output Voltage | -1.02 | -0.84 | -0.98 | -0.81 | -0.92 | -0.735 | Vdc |
| V _{OL} | Low Output Voltage | -1.95 | -1.63 | -1.95 | -1.63 | -1.95 | -1.60 | Vdc |
| V _{IH} | High Input Voltage | -1.17 | -0.84 | -1.13 | -0.81 | -1.07 | -0.735 | Vdc |
| V _{IL} | Low Input Voltage | -1.95 | -1.48 | -1.95 | -1.48 | -1.95 | -1.45 | Vdc |

Each MECL 10HTM series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained. Outputs are terminated through a 50 Ω resistor to -2.0 V.

Table 3. AC PARAMETERS

| | | 0 | 0 | 2 | 5° | 7 | 75° | |
|-----------------|---|------------|------------|------------|------------|------------|------------|------|
| Symbol | Characteristic | Min | Max | Min | Max | Min | Max | Unit |
| t _{pd} | Propagation Delay Data-to-Output Enable-to-Output | 1.1 0.6 | 3.5 1.7 | 1.1 0.7 | 3.7 1.7 | 1.2 0.7 | 4.1 1.8 | ns |
| t _r | Rise Time | 0.6 | 1.5 | 0.6 | 1.6 | 0.6 | 1.7 | ns |
| t _f | Fall Time | 0.6 | 1.5 | 0.6 | 1.6 | 0.6 | 1.7 | ns |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

LOGIC DIAGRAM

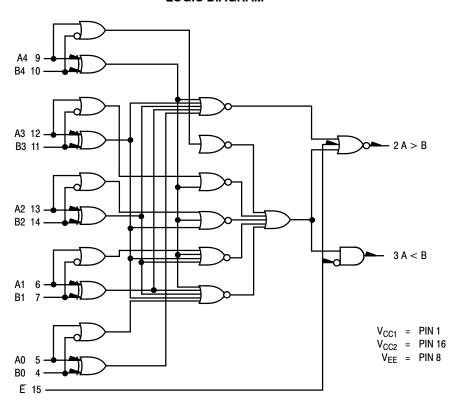
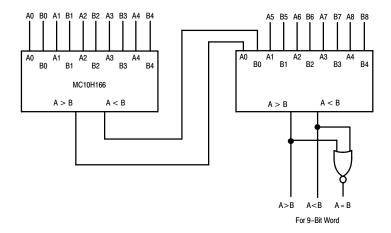
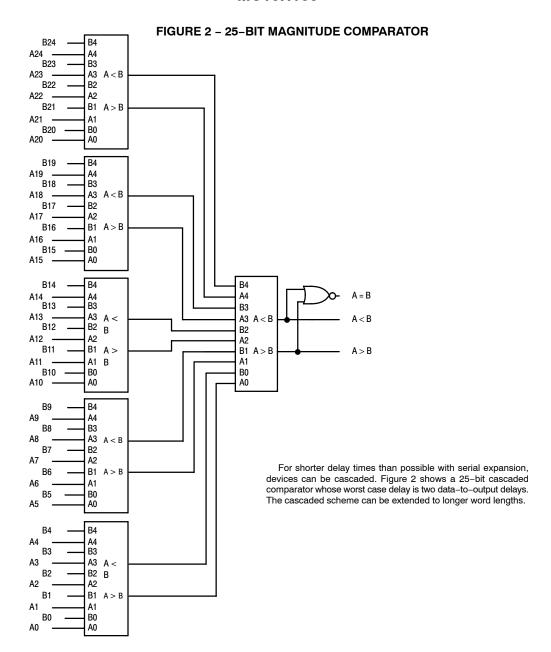


FIGURE 1 - 9-BIT MAGNITUDE COMPARATOR



For longer word lengths, the MC10H166 can be serially expanded or cascaded. Figure 1 shows two devices in a serial expansion for a 9-bit word length. The A > B and A < B outputs are fed to the A0 and B0 inputs respectively

of the next device. The connection for an A=B output is also shown. The worst case delay time of serial expansion is equal to the number of comparators times the data—to—output delay.



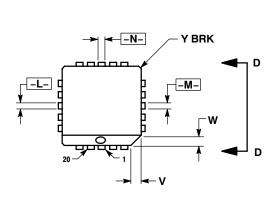
ORDERING INFORMATION

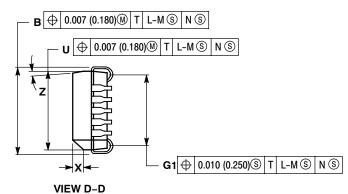
| Device | Package | Shipping [†] |
|---------------|----------------------|-----------------------|
| MC10H166FN | PLLC-20 | 46 Units / Rail |
| MC10H166FNG | PLLC-20 (Pb-Free) | 46 Units / Rail |
| MC10H166FNR2 | PLLC-20 | 500 / Tape & Reel |
| MC10H166FNR2G | PLLC-20 (Pb-Free) | 500 / Tape & Reel |
| MC10H166L | CDIP-16 | 25 Unit / Rail |
| MC10H166P | PDIP-16 | 25 Unit / Rail |
| MC10H166PG | PDIP-16 (Pb-Free) | 25 Unit / Rail |

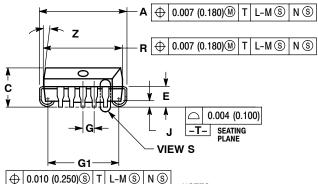
[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

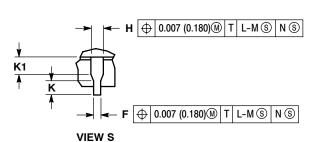
PACKAGE DIMENSIONS

20 LEAD PLLC CASE 775-02 **ISSUE E**









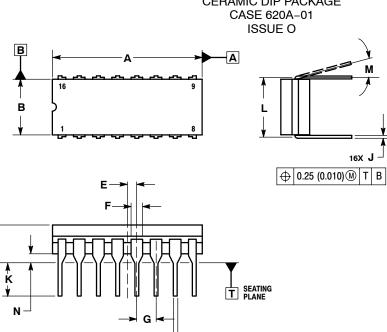
- NOTES:
 1. DIMENSIONS AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. DIMENSIONS IN INCHES.
 3. DATUMS -L., -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.

- PARTING LINE.
 4. DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM —T—, SEATING PLANE.
 5. DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
 6. DIMENSIONS IN THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- PLASTIC BODY.
 7. DIMENSION H DOES NOT INCLUDE DAMBAR DIMIENSION HOUSEN OF INCLUDE DAMBAR
 PROTRUSION OR INTRUSION. THE DAMBAR
 PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION
 TO BE GREATER THAN 0.037 (0.940). THE DAMBAR
 INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO
 BE SMALLER THAN 0.025 (0.635).

| | INCHES | | MILLIN | IETERS | | |
|-----|--------|-------|--------|--------|--|--|
| DIM | MIN | MAX | MIN | MAX | | |
| Α | 0.385 | 0.395 | 9.78 | 10.03 | | |
| В | 0.385 | 0.395 | 9.78 | 10.03 | | |
| С | 0.165 | 0.180 | 4.20 | 4.57 | | |
| Е | 0.090 | 0.110 | 2.29 | 2.79 | | |
| F | 0.013 | 0.019 | 0.33 | 0.48 | | |
| G | 0.050 | BSC | 1.27 | BSC | | |
| Н | 0.026 | 0.032 | 0.66 | 0.81 | | |
| J | 0.020 | | 0.51 | | | |
| K | 0.025 | | 0.64 | | | |
| R | 0.350 | 0.356 | 8.89 | 9.04 | | |
| U | 0.350 | 0.356 | 8.89 | 9.04 | | |
| ٧ | 0.042 | 0.048 | 1.07 | 1.21 | | |
| W | 0.042 | 0.048 | 1.07 | 1.21 | | |
| Х | 0.042 | 0.056 | 1.07 | 1.42 | | |
| Υ | | 0.020 | | 0.50 | | |
| Z | 2° | 10° | 2° | 10 ° | | |
| G1 | 0.310 | 0.330 | 7.88 | 8.38 | | |
| K1 | 0.040 | | 1.02 | | | |

PACKAGE DIMENSIONS

CDIP-16 **L SUFFIX** CERAMIC DIP PACKAGE CASE 620A-01 ISSUE O



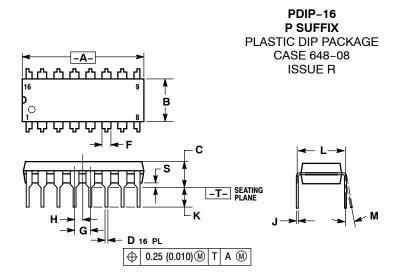
- 16X D

⊕ 0.25 (0.010) M T A

- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
 4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.
 5. THIS DRAWING REPLACES OBSOLETE CASE OUTLINE 620-10.

| | INC | HES | MILLIN | IETERS | |
|-----|---------|-----------|----------|--------|--|
| DIM | MIN MAX | | MIN | MAX | |
| Α | 0.750 | 0.785 | 19.05 | 19.93 | |
| В | 0.240 | 0.295 | 6.10 | 7.49 | |
| С | | 0.200 | | 5.08 | |
| D | 0.015 | 0.020 | 0.39 | 0.50 | |
| E | 0.050 | BSC | 1.27 BSC | | |
| F | 0.055 | 0.065 | 1.40 | 1.65 | |
| G | 0.100 | 0.100 BSC | | BSC | |
| Н | 0.008 | 0.015 | 0.21 | 0.38 | |
| K | 0.125 | 0.170 | 3.18 | 4.31 | |
| L | 0.300 | BSC | 7.62 BSC | | |
| M | 0° | 15° | 0° | 15° | |
| N | 0.020 | 0.040 | 0.51 | 1.01 | |

PACKAGE DIMENSIONS



NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
- DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
 DIMENSION B DOES NOT INCLUDE MOLD FLASH.
 ROUNDED CORNERS OPTIONAL.

| | INC | HES | MILLIN | IETERS |
|-----|-------|-------|--------|--------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 0.740 | 0.770 | 18.80 | 19.55 |
| В | 0.250 | 0.270 | 6.35 | 6.85 |
| С | 0.145 | 0.175 | 3.69 | 4.44 |
| D | 0.015 | 0.021 | 0.39 | 0.53 |
| F | 0.040 | 0.70 | 1.02 | 1.77 |
| G | 0.100 | BSC | 2.54 | BSC |
| Н | 0.050 | BSC | 1.27 | BSC |
| J | 0.008 | 0.015 | 0.21 | 0.38 |
| K | 0.110 | 0.130 | 2.80 | 3.30 |
| L | 0.295 | 0.305 | 7.50 | 7.74 |
| M | 0° | 10° | 0° | 10 ° |
| S | 0.020 | 0.040 | 0.51 | 1.01 |

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